

Normally – OFF Silicon Carbide Super Junction Transistor

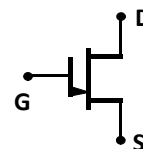
V_{DS}	=	650 V
$V_{DS(ON)}$	=	1.5 V
I_D	=	15 A
$R_{DS(ON)}$	=	105 mΩ

Features

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Electrically isolated base-plate
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- Positive temperature coefficient for easy paralleling
- Low gate charge
- Low intrinsic capacitance

Package

- RoHS Compliant



TO – 257 (Isolated Base-plate Hermetic Package)

Advantages

- Low switching losses
- Higher efficiency
- High temperature operation
- High short circuit withstand capability

Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

Maximum Ratings at $T_j = 250\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	V_{DS}	$V_{GS} = 0\text{ V}$	650	V
Continuous Drain Current	I_D	$T_C = 155\text{ °C}$	15	A
Gate Peak Current	I_{GM}		5	A
Reverse Gate – Source Voltage	V_{GS}		200	V
Reverse Drain – Source Voltage	V_{DS}		40	V
Power Dissipation	P_{tot}	$T_C = 25\text{ °C}$	22	W
Operating and Storage Temperature	T_j, T_{stg}		-55 to 250	°C

Electrical Characteristics at $T_j = 250\text{ °C}$, unless otherwise specified

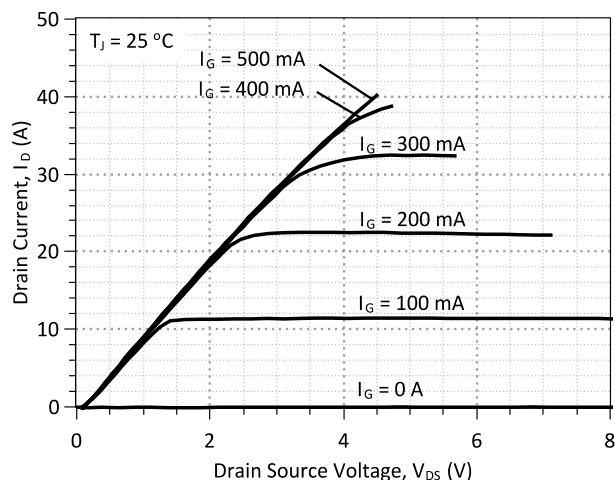
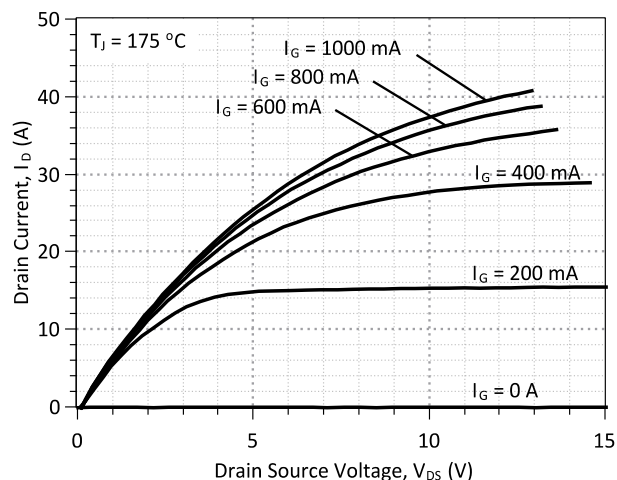
Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
On Characteristics						
Drain – Source On Voltage	$V_{DS(ON)}$	$I_D = 15\text{ A}, I_G = 500\text{ mA}, T_J = 25\text{ }^{\circ}\text{C}$		1.5		V
		$I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_J = 175\text{ }^{\circ}\text{C}$		2.4		
		$I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_J = 250\text{ }^{\circ}\text{C}$		3.6		
Drain – Source On Resistance	$R_{DS(ON)}$	$I_D = 15\text{ A}, I_G = 500\text{ mA}, T_J = 25\text{ }^{\circ}\text{C}$		105		mΩ
		$I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_J = 175\text{ }^{\circ}\text{C}$		180		
		$I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_J = 250\text{ }^{\circ}\text{C}$		290		
Gate Forward Voltage	$V_{GS(FWD)}$	$I_G = 500\text{ mA}, T_J = 25\text{ }^{\circ}\text{C}$		3		V
		$I_G = 500\text{ mA}, T_J = 250\text{ }^{\circ}\text{C}$		2.6		
DC Current Gain	β	$V_{DS} = 5\text{ V}, I_D = 20\text{ A}, T_J = 25\text{ }^{\circ}\text{C}$		115		
		$V_{DS} = 5\text{ V}, I_D = 20\text{ A}, T_J = 250\text{ }^{\circ}\text{C}$		75		
Off Characteristics						
Drain Leakage Current	I_{DSS}	$V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_J = 25\text{ }^{\circ}\text{C}$		1		μA
		$V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^{\circ}\text{C}$		7		
		$V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_J = 250\text{ }^{\circ}\text{C}$		45		

Electrical Characteristics at $T_J = 250^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 35\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$, $T_{vj} = 25\text{ }^{\circ}\text{C}$		1534		pF
Output Capacitance	C_{oss}			157		pF
Reverse Transfer Capacitance	C_{rss}			157		pF
Switching Characteristics						
Turn On Delay Time	$t_{d(on)}$	$V_{DD} = 400\text{ V}$, $I_D = 20\text{ A}$, $R_{G(on)} = R_{G(off)} = 22\text{ }\Omega$, $V_{GS} = -8/15\text{ V}$, $T_J = 175\text{ }^{\circ}\text{C}$ Refer to Figure 10 for gate drive current waveforms		5		ns
Rise Time	t_r			37		ns
Turn Off Delay Time	$t_{d(off)}$			68		ns
Fall Time	t_f			78		ns
Turn-On Energy Per Pulse	E_{on}			66		μJ
Turn-Off Energy Per Pulse	E_{off}	$V_{DD} = 400\text{ V}$, $I_D = 10\text{ A}$, $R_{G(on)} = R_{G(off)} = 22\text{ }\Omega$, $V_{GS} = -8/15\text{ V}$, $T_J = 250\text{ }^{\circ}\text{C}$ Refer to Figure 10 for gate drive current waveforms		365		μJ
Total Switching Energy	E_{ts}			431		μJ
Turn On Delay Time	$t_{d(on)}$			7		ns
Rise Time	t_r			38		ns
Turn Off Delay Time	$t_{d(off)}$			85		ns
Fall Time	t_f			86		ns
Turn-On Energy Per Pulse	E_{on}			64		μJ
Turn-Off Energy Per Pulse	E_{off}			395		μJ
Total Switching Energy	E_{ts}			459		μJ

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	1.4	$^\circ\text{C/W}$
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Figure 1: Typical Output Characteristics at 25 °C

Figure 2: Typical Output Characteristics at 175 °C

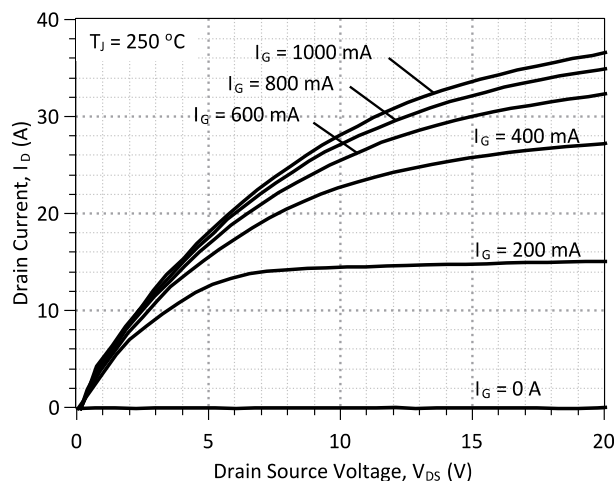


Figure 3: Typical Output Characteristics at 250 °C

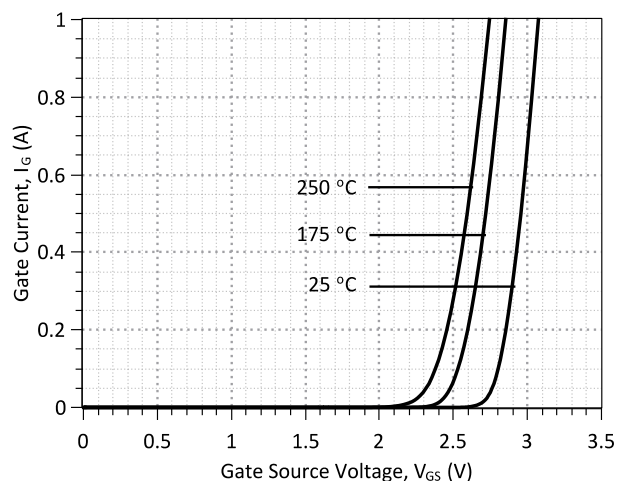


Figure 4: Typical Gate Source I-V Characteristics vs. Temperature

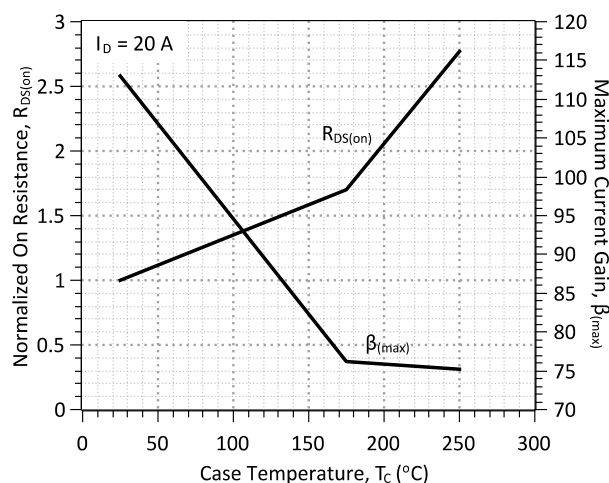


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

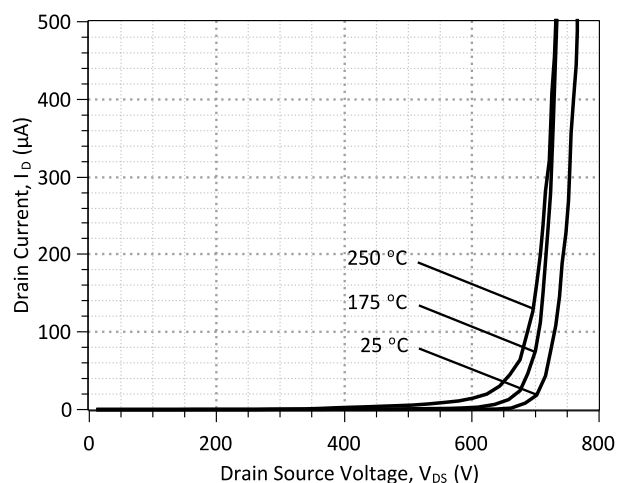


Figure 6: Typical Blocking Characteristics

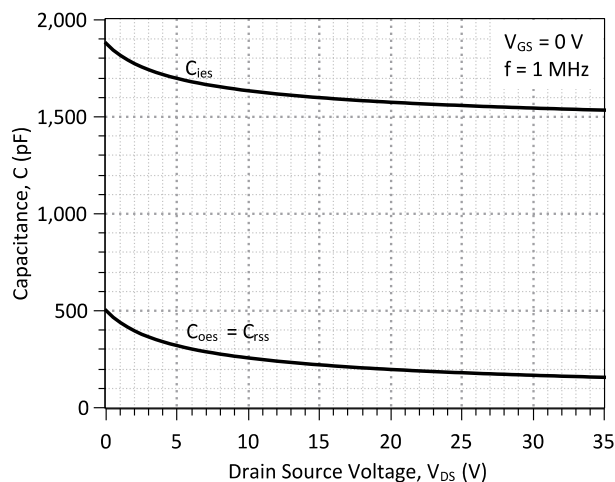


Figure 7: Typical Capacitance vs Drain-Source Voltage

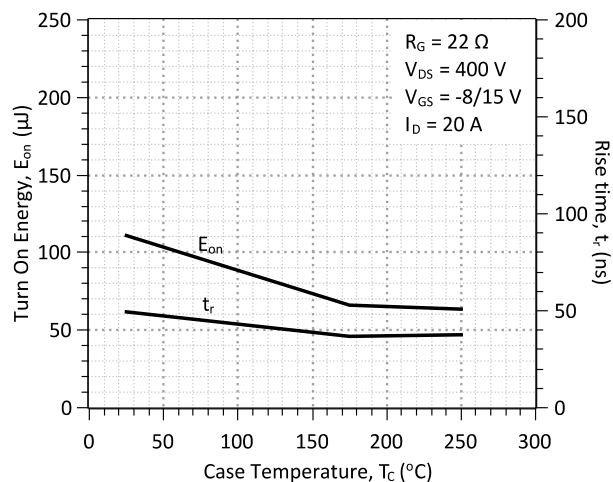


Figure 8: Typical Turn On Energy Losses and Switching Times vs. Temperature

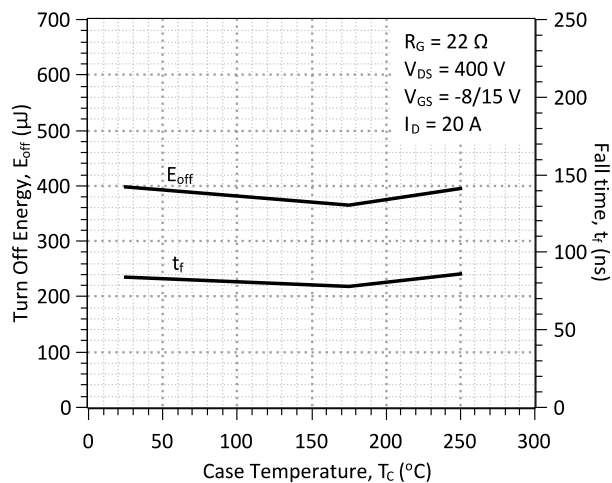


Figure 9: Typical Turn Off Energy Losses and Switching Times vs. Temperature

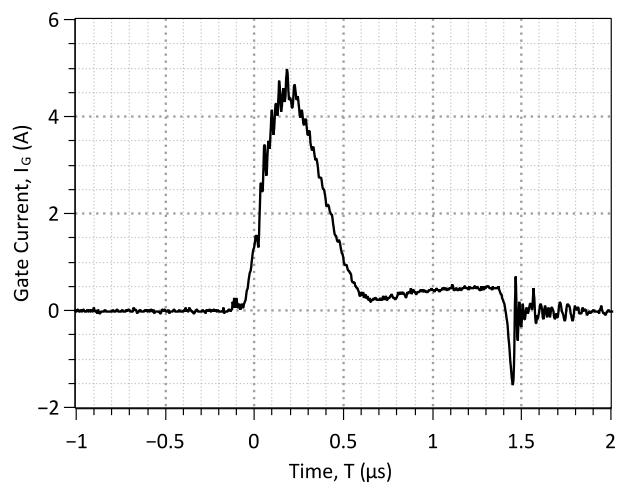
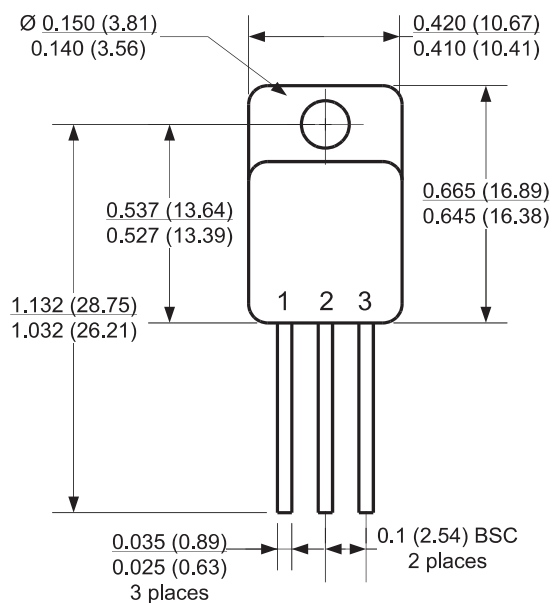


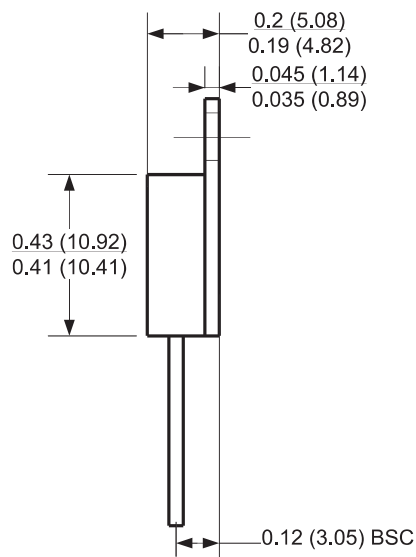
Figure 10: Typical Gate-Source Switching Waveforms

Package Dimensions:

TO-257



PACKAGE OUTLINE



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History

Date	Revision	Comments	Supersedes
2012/08/24	0	Initial release	

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